

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of:) Anticipated Art Unit: 3629
Seungbae Park et al) Examiner: Not yet assigned
Serial No.: Not yet assigned) Date: January 3, 2002
Filed: concurrently herewith) Atty. Docket No.: EN999048D
For: SOLDER INTERCONNECT)
TECHNIQUES)

PRELIMINARY AMENDMENT

Commissioner of Patents and Trademarks
Washington, DC 20231

S I R:

Please amend the above-identified patent application as
shown below.

IN THE CLAIMS:

Please cancel claims 2 and 7.

IN THE SPECIFICATION:

Please replace the paragraph beginning on page 3, line 16 with the following rewritten paragraph:

--In United States Patent No. 5,118,299, issued to Burns et al, on June 2, 1992, for CONE ELECTRICAL CONTACT, an electrical interconnection is shown featuring two detachable surfaces having intermeshing cone projections. The cones enhance ohmic contact by intermeshing and wiping.--

Please replace the paragraph beginning on page 6, line 1 with the following rewritten paragraph:

--FIGURE 1 illustrates a side view of the edge of the solder boundary of a prior art metallic pad.--

REMARKS

The above-identified patent application is a divisional application of parent case, Serial No. 09/430,965, filed

November 1, 1999, now allowed. Claims 2 and 7 have been canceled. Claims 1, 3 - 6 and 8 remain in the case.

Attached hereto is a marked-up version of the changes made to the specification, claims and abstract by the current amendment. The attached page is captioned "Version with markings to show changes made."

Respectfully submitted,



David L. Banner
Registration No. 39,898
Agent for Applicants
Press Building - Suite 902
19 Chenango Street
Binghamton, New York 13901

Phone: (607) 722-6600

VERSION WITH MARKINGS TO SHOW CHANGES MADE

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